Welcome to [E-XFL.COM](#)**Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

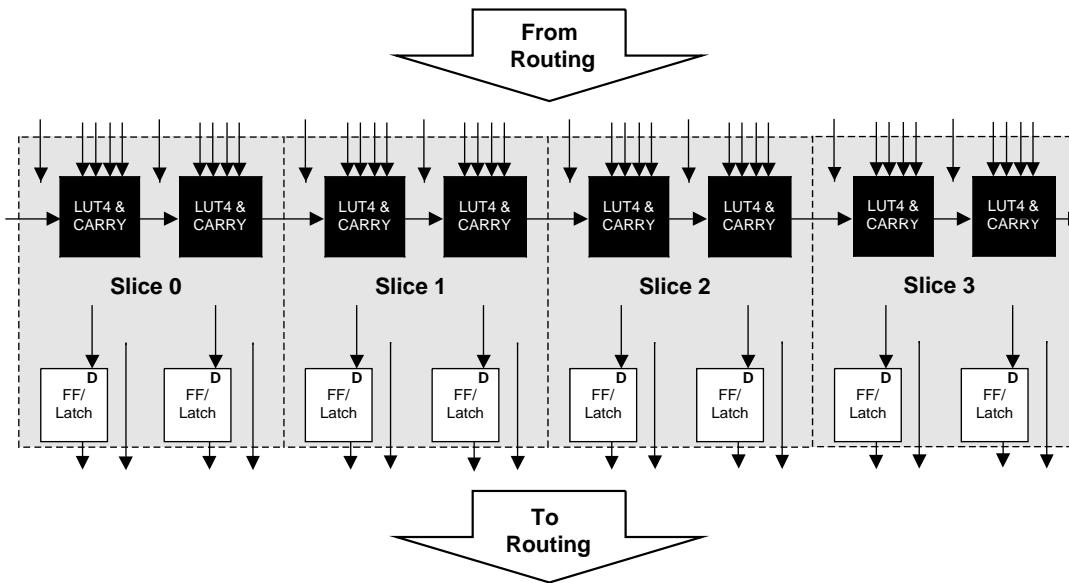
Product Status	Obsolete
Number of LABs/CLBs	6250
Number of Logic Elements/Cells	25000
Total RAM Bits	1966080
Number of I/O	476
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFcBGA Rev 2 (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga25e-6ffan1020i

PFU Blocks

The core of the LatticeSC devices consists of PFU blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-2. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-2. PFU Diagram



Slice

Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to implement 5, 6, 7 and 8 Input LUTs (LUT5, LUT6, LUT7 and LUT8). There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-3 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

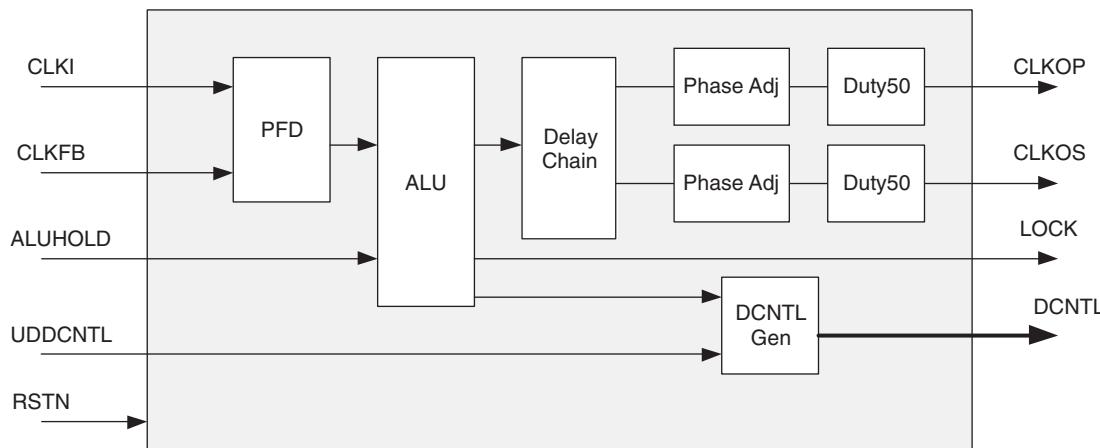
There is a Digital Control (DCNTL) bus available from the DLL block. This Digital Control bus is available to the delay lines in the PIC blocks in the adjacent banks. The UDDCNTL signal allows the user to latch the current value on the digital control bus.

Figure 2-12 shows the DLL block diagram of the DLL inputs and outputs. The output of the phase frequency detector controls an arithmetic logic unit (ALU) to add or subtract one delay tap. The digital output of this ALU is used to control the delay value of the delay chain and this digital code is transmitted via the DCNTL bus.

The sysCLOCK DLL can be configured at power-up, then, if desired, reconfigured dynamically through the Serial Memory Interface bus which interfaces with the on-chip Microprocessor Interface (MPI) bus. In addition, users can drive the SMI interface from routing if desired.

The user can configure the DLL for many common functions such as clock injection match and single delay cell. Lattice provides primitives in its design for time reference delay (DDR memory) and clock injection delay removal.

Figure 2-12. DLL Diagram



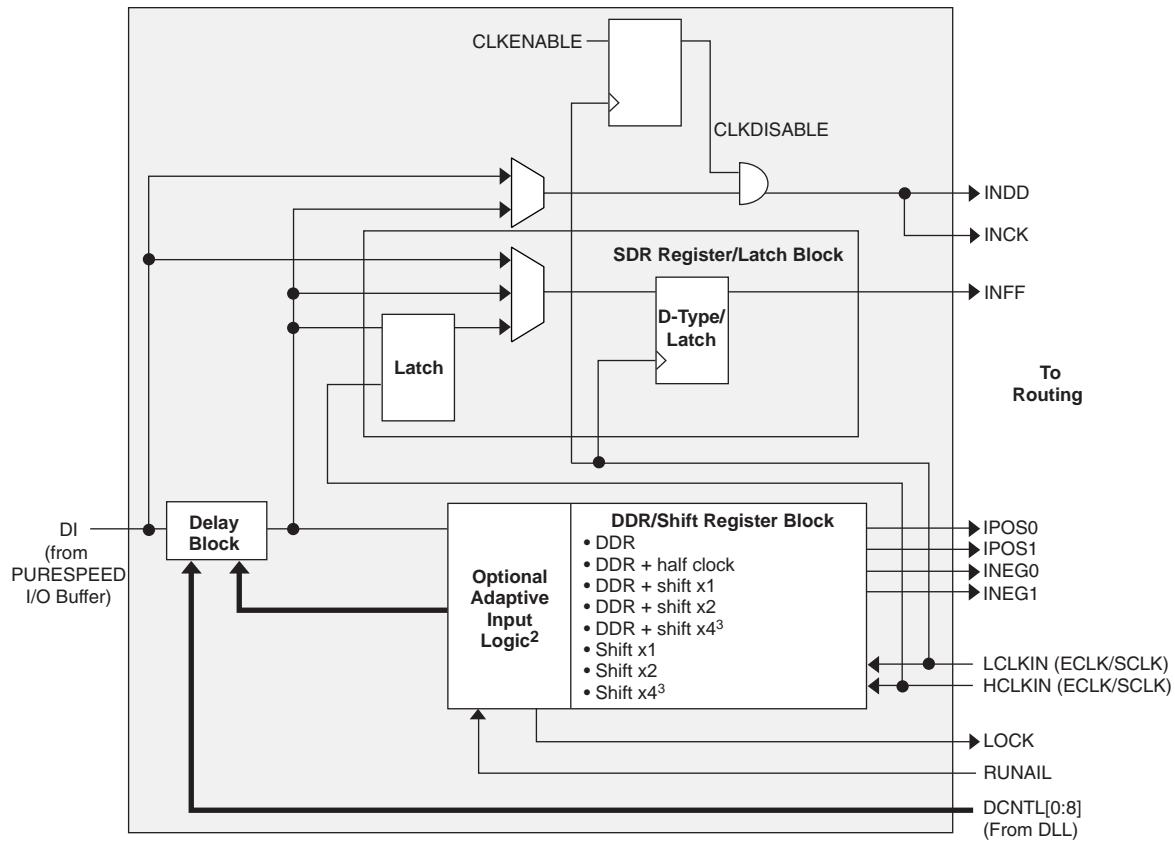
PLL/DLL Cascading

The LatticeSC devices have been designed to allow certain combinations of PLL and DLL cascading. The allowable combinations are as follows:

- PLL to PLL
- PLL to DLL
- DLL to DLL
- DLL to PLL

DLLs are used to shift the clock in relation to the data for source synchronous inputs. PLLs are used for frequency synthesis and clock generation for source synchronous interfaces. Cascading PLL and DLL blocks allows applications to utilize the unique benefits of both DLL and PLLs.

When cascading the DLL to the PLL, the DLL can be used to drive the PLL to create fine phase shifts of an input clock signal. Figure 2-13 shows a shift of all outputs for CLKOP and CLKOS out in time.

Figure 2-20. Input Register Block¹

1. UPDATE, Set and Reset not shown for clarity

2. Adaptive input logic is only available in selected PIO

3. By four shift modes utilize DDR/shift register block from paired PIO.

4. CLKDISABLE is used to block the transitions on the DQS pin during post-amble. Its main use is to disable DQS (typically found in DDR memory interfaces) or other clock signals. It can also be used to disable any/all input signals to save power.

3. Bottom Side (Banks 4 and 5)

These buffers can support LVC MOS standards up to 3.3V, including PCI33, PCI-X33 and SSTL-33. Differential receivers are provided on all PIO pairs but true HLVDS and RSDS differential drivers are not available. Adaptive input logic is available on PIOs A or C.

Table 2-8 lists the standards supported by each side.

Table 2-8. I/O Standards Supported by Different Banks

Description	Top Side Banks 1	Right Side Banks 2-3	Bottom Side Banks 4-5	Left Side Banks 6-7
I/O Buffer Type	Single-ended, Differential Receiver	Single-ended, Differential Receiver and Driver	Single-ended, Differential Receiver	Single-ended, Differential Receiver and Driver
Output Standards Supported	LVTTL LVC MOS33 LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18_I, II SSTL25_I, II SSTL33_I, II HSTL15_I, II, III ¹ , IV ¹ HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II SSTL18D_I, II SSTL25D_I, II SSTL33D_I, II HSTL15D_I, II HSTL18D_I, II PCI33 PCIX15 PCIX33 AGP1X33 AGP2X33 MLVDS/BLVDS GTL ² , GTL+ ²	LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III PCIX15 SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II SSTL33D_I, II LVDS/RSDS Mini-LVDS MLVDS/BLVDS GTL ² , GTL+ ²	LVTTL LVC MOS33 LVC MOS25 LVC MOS18 LVC MOS15 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III ¹ , IV ¹ HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II SSTL33D_I, II LVDS/RSDS HSTL15D_I, II HSTL18D_I, II PCI33 PCIX15 PCIX33 AGP1X33 AGP2X33 MLVDS/BLVDS GTL ² , GTL+ ²	LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II SSTL33D_I, II LVDS/RSDS Mini-LVDS MLVDS/BLVDS GTL ² , GTL+ ²
Input Standards Supported	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential
Clock Inputs	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential
Differential Output Support via Emulation	LVDS/MLVDS/BLVDS/ LVPECL	MLVDS/BLVDS/ LVPECL	LVDS/MLVDS/BLVDS/ LVPECL	MLVDS/BLVDS/ LVPECL
AIL Support	No	Yes	Yes	Yes

1. Input only.

2. Input only. Outputs supported by bussing multiple outputs together.

Supported Standards

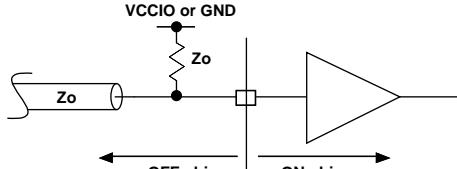
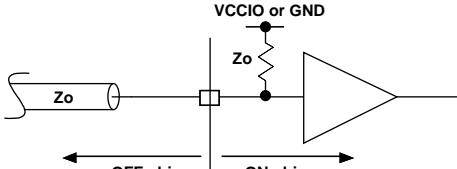
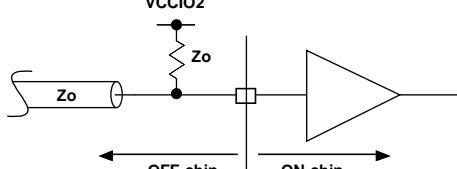
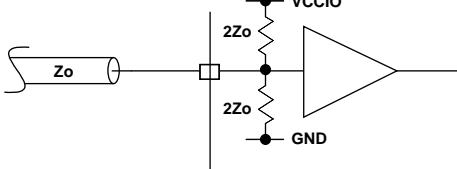
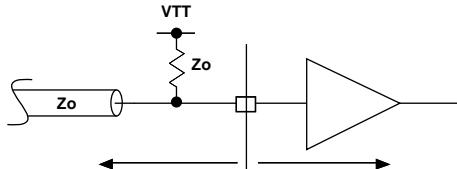
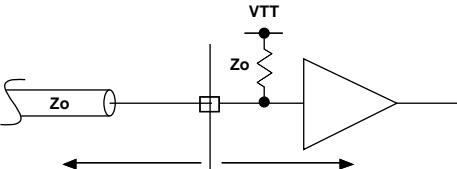
The LatticeSC PURE SPEED I/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVC MOS, LVTTL and other standards. The buffers support the LVTTL, LVC MOS 12, 15, 18, 25 and 33 standards. In the LVC MOS and LVTTL modes, the buffer has individually configurable options for drive strength, termination resistance, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL, HSTL, GTL (input only), GTL+ (input only), PCI33, PCIX33, PCIX15, AGP-1X33 and AGP-2X33. Differential standards supported include LVDS, RSDS, BLVDS, MLVDS, LVPECL, differential SSTL and differential HSTL. Tables 12 and 13 show the I/O standards (together with their supply and reference voltages) supported by the LatticeSC devices. The tables also provide the available internal termination schemes. For further information on utilizing the PURE SPEED I/O buffer to support a variety of standards please see details of additional technical documentation at the end of this data sheet.

Single Ended Inputs: The SC devices support a number of different termination schemes for single ended inputs:

- Parallel to V_{CCIO} or GND
- Parallel to $V_{CCIO}/2$
- Parallel to V_{TT}

Figure 2-28 shows the single ended input schemes that are supported. The nominal values of the termination resistors are shown in Table 2-9.

Figure 2-28. Input Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Parallel termination to V_{CCIO} , or parallel to GND receiving end		
Parallel termination to $V_{CCIO}/2$ receiving end		
Parallel termination to V_{TT} at receiving end		

In many situations designers can chose whether to use Thevenin or parallel to V_{TT} termination. The Thevenin approach has the benefit of not requiring a termination voltage to be applied to the device. The parallel to V_{TT} approach consumes less power.

VTT Termination Resources

Each I/O bank, except bank 1, has a number of V_{TT} pins that must be connected if V_{TT} is used. Note V_{TT} pins can sink or source current and the power supply they are connected to must be able to handle the relatively high currents associated with the termination circuits. Note: V_{TT} is not available in all package styles.

On-chip parallel termination to V_{TT} is supported at the receiving end only. On-chip parallel output termination to V_{TT} is not supported.

The V_{TT} internal bus is also connected to the internal V_{CMT} node. Thus in one bank designers can implement either V_{TT} termination or V_{CMT} termination for differential inputs.

DDRII/RDRAMII Termination Support

The DDR II memory and RDRAMII (in Bidirection Data mode) standards require that the on-chip termination to V_{TT} be turned on when a pin is an input and off when the pin is an output. The LatticeSC devices contain the required circuitry to support this behavior. For additional detail refer to technical information at the end of the data sheet.

- 8-bit SERDES Only
- 10-bit SERDES Only
- SONET (STS-12/STS-48)
- Gigabit Ethernet
- Fibre Channel
- XAUI
- Serial RapidIO
- PCI-Express
- Generic 8b10b

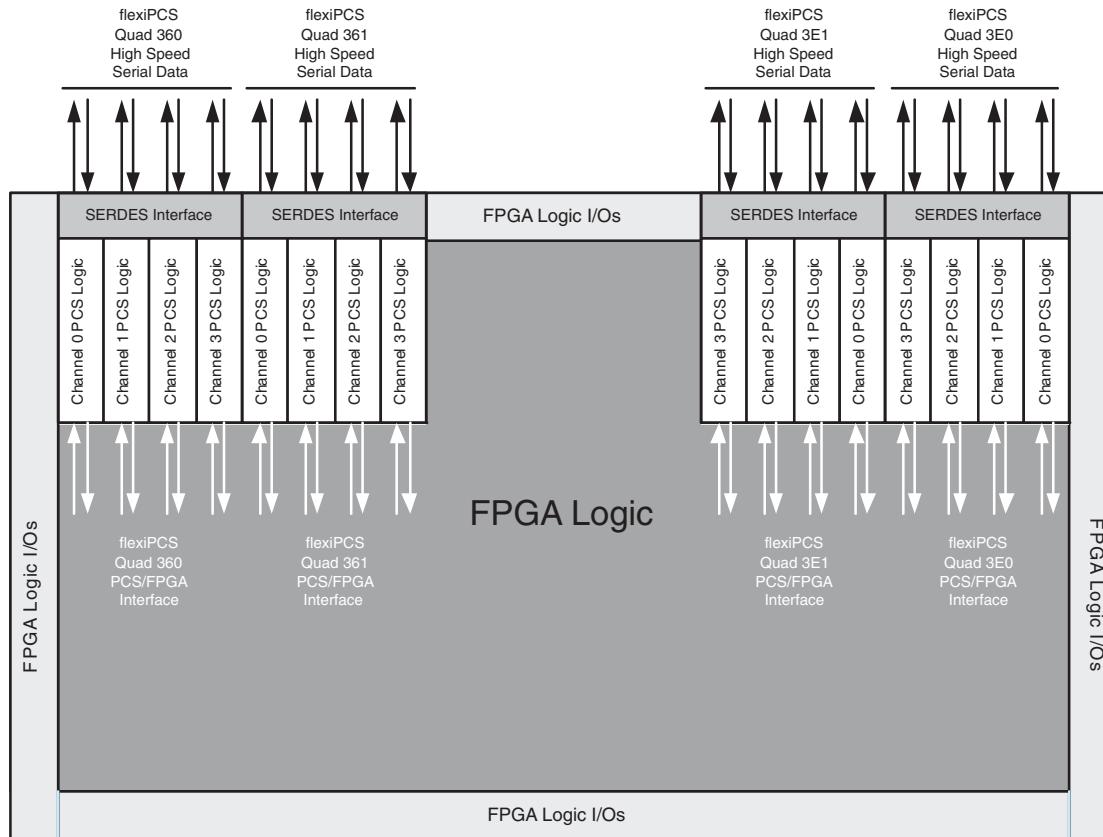
flexiPCS Quad

The flexiPCS logic is arranged in quads containing logic for four independent full-duplex data channels. Each device in the LatticeSC family has up to eight quads of flexiPCS logic. The LatticeSC Family Selection Guide table on the first page of this data sheet contains the number of flexiPCS channels present on the chip. Note that in some packages (particularly lower pin count packages), not all channels from all quads on a given device may be bonded to package pins.

Each quad supports up to four channels of full-duplex data and can be programmed into any one of several protocol based modes. Each quad requires its own reference clock which can be sourced externally or from the FPGA logic. The user can utilize between one and four channels in a quad, depending on the application.

Figure 2-30 shows an example of four flexiPCS quads in a LatticeSC device. Quads are labeled according to the address of their software controlled registers.

Figure 2-30. LatticeSC flexiPCS



Since each quad has its own reference clock, different quads can support different standards on the same chip. This feature makes the LatticeSC family of devices ideal for bridging between different standards.

PURESPEED I/O Recommended Operating Conditions

Standard	V_{CCIO} (V)			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 33	3.135	3.3	3.465	—	—	—
LVCMOS 25	2.375	2.5	2.625	—	—	—
LVCMOS 18	1.71	1.8	1.89	—	—	—
LVCMOS 15	1.425	1.5	1.575	—	—	—
LVCMOS 12	1.14	1.2	1.26	—	—	—
LVTTL	3.135	3.3	3.465	—	—	—
PCI33	3.135	3.3	3.465	—	—	—
PCIX33	3.135	3.3	3.465	—	—	—
PCIX15	1.425	1.5	1.575	$0.49V_{CCIO}$	$0.5V_{CCIO}$	$0.51V_{CCIO}$
AGP1X33	3.135	3.3	3.465	—	—	—
AGP2X33	3.135	3.3	3.465	$0.39V_{CCIO}$	$0.4V_{CCIO}$	$0.41V_{CCIO}$
SSTL18_I, II ³	1.71	1.8	1.89	0.833	0.9	0.969
SSTL25_I, II ³	2.375	2.5	2.625	1.15	1.25	1.35
SSTL33_I, II ³	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15_I, II ³	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15_III ^{1,3} and IV ^{1,3}	1.425	1.5	1.575	0.68	0.9	0.9
HSTL 18_I ³ , II ³	1.71	1.8	1.89	0.816	0.9	1.08
HSTL 18_ III ^{1,3} , IV ^{1,3}	1.71	1.8	1.89	0.816	1.08	1.08
GTL12 ^{1,3} , GTLPLUS15 ^{1,3}	—	—	—	0.882	1.0	1.122
LVDS	—	—	—	—	—	—
Mini-LVDS	—	—	—	—	—	—
RSDS	—	—	—	—	—	—
LVPECL33 (outputs) ²	3.135	3.3	3.465	—	—	—
LVPECL33 (inputs) ^{2,4}	—	≤ 2.5	—	—	—	—
BLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
MLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
SSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—
SSTL25D_I ³ , II ³	2.375	2.5	2.625	—	—	—
SSTL33D_I ³ , II ³	3.135	3.3	3.465	—	—	—
HSTL15D_I ³ , II ³	1.425	1.5	1.575	—	—	—
HSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—

1. Input only.

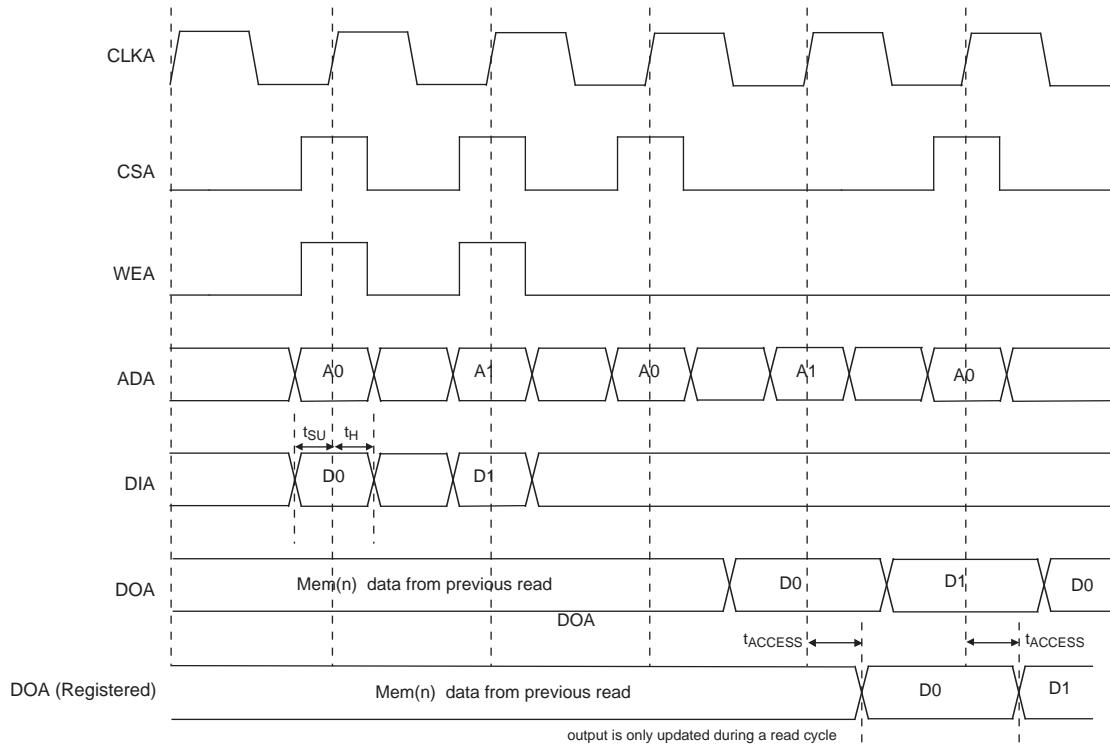
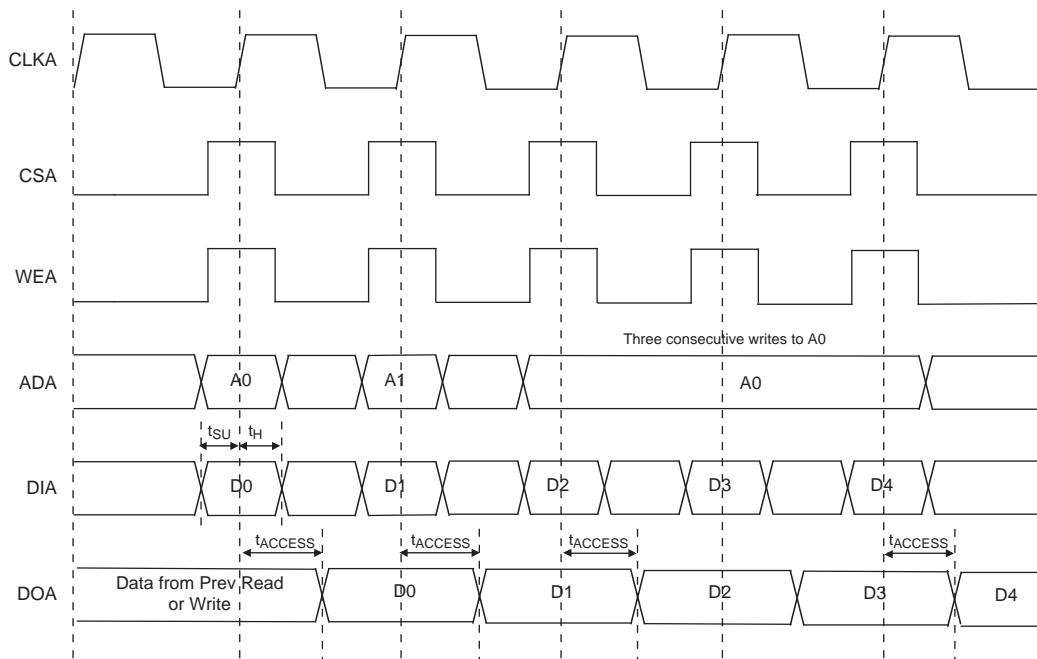
2. Inputs on chip. Outputs are implemented with the addition of external resistors.

3. Input for this standard does not depend on the value of V_{CCIO} .4. Inputs for this standard cannot be in 3.3V VCCIO banks ($\leq 2.5V$ only).

LatticeSC/M Family Timing Adders (Continued)

Over Recommended Operating Conditions at VCC = 1.2V +/- 5%

Buffer Type	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
LVCMOS18_12mA	LVCMOS 1.8 12mA drive	0.024	-0.106	0.019	-0.004	0.016	0.099	ns
LVCMOS18_16mA	LVCMOS 1.8 16mA drive	0.074	-0.134	0.08	-0.022	0.088	0.089	ns
LVCMOS18_OD	LVCMOS 1.8 open drain	0.002	-0.206	0	-0.196	-0.002	-0.221	ns
LVCMOS15_4mA	LVCMOS 1.5 4mA drive	-0.344	-0.164	-0.379	-0.186	-0.412	-0.209	ns
LVCMOS15_8mA	LVCMOS 1.5 8mA drive	-0.125	-0.137	-0.145	-0.157	-0.164	-0.176	ns
LVCMOS15_12mA	LVCMOS 1.5 12mA drive	-0.027	-0.166	-0.043	-0.07	-0.059	0.026	ns
LVCMOS15_16mA	LVCMOS 1.5 16mA drive	0.025	-0.195	0.013	-0.089	0.003	0.017	ns
LVCMOS15_OD	LVCMOS 1.5 open drain	-0.047	-0.267	-0.067	-0.267	-0.087	-0.299	ns
LVCMOS12_2mA	LVCMOS 1.2 2mA drive	-0.473	-0.293	-0.505	-0.317	-0.537	-0.34	ns
LVCMOS12_4mA	LVCMOS 1.2 4mA drive	-0.218	-0.239	-0.25	-0.271	-0.28	-0.303	ns
LVCMOS12_8mA	LVCMOS 1.2 8mA drive	-0.109	-0.269	-0.143	-0.181	-0.176	-0.093	ns
LVCMOS12_12mA	LVCMOS 1.2 12mA drive	-0.054	-0.3	-0.085	-0.203	-0.114	-0.106	ns
LVCMOS12_OD	LVCMOS 1.2 open drain	-0.126	-0.371	-0.166	-0.398	-0.204	-0.43	ns
PCI33	PCI	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns
PCIX33	PCI-X 3.3	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns
PCIX15	PCI-X 1.5	0.208	0.227	0.233	0.312	0.259	0.398	ns
AGP1X33	AGP-1X 3.3	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns
AGP2X33	AGP-2X	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns

Figure 3-8. Read Mode with Input and Output Registers**Figure 3-9. Write Through (SP Read/Write On Port A, Input Registers Only)**

Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

LatticeSC/M sysCONFIG Port Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
General Configuration Timing				
$t_{S MODE}$	M[3:0] Setup Time to INITN High	0	—	ns
$t_{H MODE}$	M[3:0] Hold Time from INITN High	600	—	ns
t_{RW}	RESETN Pulse Width Low to Start Reconfiguration (1.2 V)	50 (or 100 at 0.95V)	—	ns
t_{PGW}	PROGRAMN Pulse Width Low to Start Reconfiguration (1.2 V)	50 (or 100 at 0.95V)	—	ns
$f_{ESB_CLK_FRQ}$	System Bus ESB_CLK Frequency (No Wait States)	—	133	MHz
sysCONFIG Master Parallel Configuration Mode				
t_{SMB}	D[7:0] Setup Time to RCLK High	6	—	ns
t_{HMB}	D[7:0] Hold Time to RCLK High	0	—	ns
t_{CLMB}	RCLK Low Time (Non-compressed Bitstreams)	0.5	0.5	CCLK periods
	RCLK Low Time (Compressed Bitstreams)	0.5	7.5	CCLK periods
t_{CHMB}	RCLK High Time	0.5	0.5	CCLK periods
sysCONFIG SPI Port				
t_{CFGX}	INITN High to CSCK Low	—	80	ns
t_{CSSPI}	INITN High to CSSPIN Low	0	2	μs
t_{SCK}	CSCK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CSCK Low to Output Valid	—	15	ns
t_{CSPID}	CSSPIN Low to CSCK high Setup Time	—	15	ns
f_{MAXSPI}	Max CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN=0)	—	50	MHz
t_{SUSPI}	SOSPI/D0 Data Setup Time Before CSCK	7	—	ns
t_{HSPI}	SOSPI/D0 Data Hold Time After CSCK	2	—	ns
	Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
	Duty Cycle	40	60	%
sysCONFIG Master Serial Configuration Mode				
t_{SMS}	DIN Setup Time	4.4	—	ns
t_{HMS}	DIN Hold Time	0	—	ns
f_{CMS}	CCLK Frequency (No Divider)	90	190	MHz
f_{C_DIV}	CCLK Frequency (Div 128)	0.70	1.48	MHz
t_D	CCLK to DOUT Delay	—	7.5	ns
sysCONFIG Master Parallel Configuration Mode				
t_{AVMP}	RCLK to Address Valid	—	10	ns
t_{SMP}	D[7:0] Setup Time to RCLK High	6	—	ns
t_{HMP}	D[7:0] Hold Time to RCLK High	0	—	ns
t_{CLMP}	RCLK Low Time (Non-compressed Bitstream)	7.5	7.5	CCLK periods
	RCLK Low Time (Compressed Bitstream)	0.5	63.5	CCLK periods
t_{CHMP}	RCLK High Time	0.5	0.5	CCLK periods
t_{DMP}	CCLK to DOUT	—	7.5	ns

Pin Information Summary (Cont.)

Pin Type	1152 fcBGA			1704 fcBGA	
	LFSC/M40	LFSC/M80	LFSC/M115	LFSC/M80	LFSC/M115
Single Ended User I/O	604	660	660	904	942
Differential Pair User I/O	302	330	330	452	470
LVDS Output Pairs	78	102	102	114	132
Configuration	Dedicated	11	11	11	11
	Muxes/MPI sysBus	72	72	72	72
JTAG (excluding VCCJ)	4	4	4	4	4
Dedicated Pins	4	4	4	4	4
VCC	44	44	44	76	76
VCC12	52	52	52	88	88
VCCAUX	38	38	38	52	52
VCCIO	Bank 1	10	10	10	10
	Bank 2	9	9	12	12
	Bank 3	12	12	14	14
	Bank 4	12	12	14	14
	Bank 5	12	12	14	14
	Bank 6	12	12	14	14
	Bank 7	9	9	12	12
VTT	Bank 2	3	3	4	4
	Bank 3	3	3	4	4
	Bank 4	3	3	5	5
	Bank 5	3	3	5	5
	Bank 6	3	3	4	4
	Bank 7	3	3	4	4
GND	130	130	130	184	184
NC	62	6	6	52	14
Single Ended User / Differential I/O per Bank	Bank 1	80/40	80/40	80/40	80/40
	Bank 2	60/30	76/38	76/38	96/48
	Bank 3	96/48	108/54	108/54	132/66
	Bank 4	106/53	106/53	106/53	184/92
	Bank 5	106/53	106/53	106/53	184/92
	Bank 6	96/48	108/54	108/54	132/66
	Bank 7	60/30	76/38	76/38	96/48
LVDS Output Pairs Per Bank	Bank 2	15	21	21	27
	Bank 3	24	30	30	39
	Bank 6	24	30	30	39
	Bank 7	15	21	21	27
VCCJ	1	1	1	1	1
SERDES (signal + power supply)	108	108	108	212	212
Total	1152	1152	1152	1704	1704

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D14	PT15B	1	A15/MPI_ADDR29	PT25B	1	A15/MPI_ADDR29
D13	PT15A	1	A17/MPI_ADDR31	PT25A	1	A17/MPI_ADDR31
F12	PT13D	1	A19/MPI_TSIZ1	PT24D	1	A19/MPI_TSIZ1
F13	PT13C	1	A20/MPI_BDIP	PT24C	1	A20/MPI_BDIP
B12	PT11B	1	A18/MPI_TSIZ0	PT24B	1	A18/MPI_TSIZ0
B11	PT11A	1	MPI_TEA	PT24A	1	MPI_TEA
E12	PT10D	1	D14/MPI_DATA14	PT23D	1	D14/MPI_DATA14
D12	PT10C	1	DP1/MPI_PAR1	PT23C	1	DP1/MPI_PAR1
G10	PT9B	1	A21/MPI_BURST	PT23B	1	A21/MPI_BURST
G9	PT9A	1	D15/MPI_DATA15	PT23A	1	D15/MPI_DATA15
C10	A_VDDIB3_L	-		A_VDDIB3_L	-	
E9	VCC12	-		VCC12	-	
B10	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A10	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
D9	VCC12	-		VCC12	-	
A9	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C9	A_VDDOB3_L	-		A_VDDOB3_L	-	
A8	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C8	A_VDDOB2_L	-		A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E8	VCC12	-		VCC12	-	
B8	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
B7	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
C7	A_VDDIB2_L	-		A_VDDIB2_L	-	
D8	VCC12	-		VCC12	-	
C6	A_VDDIB1_L	-		A_VDDIB1_L	-	
E7	VCC12	-		VCC12	-	
B6	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A6	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
D7	VCC12	-		VCC12	-	
A5	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C5	A_VDDOB1_L	-		A_VDDOB1_L	-	
A4	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C4	A_VDDOB0_L	-		A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E6	VCC12	-		VCC12	-	
B4	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
B3	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
C3	A_VDDIB0_L	-		A_VDDIB0_L	-	
D6	VCC12	-		VCC12	-	
L5	NC	-		PL21A	7	
M5	NC	-		PL21B	7	
G2	NC	-		PL20A	7	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH20	NC	-		PB51D	4	
AK27	NC	-		NC	-	
AJ24	NC	-		NC	-	
AF17	NC	-		PB42C	4	
AH27	NC	-		PB61B	4	
AD23	NC	-		PB57A	4	
AE23	NC	-		PB57B	4	
AH24	NC	-		PB59A	4	
AH25	NC	-		PB59B	4	
AH26	NC	-		PB61A	4	
AF24	NC	-		PB63A	4	
AG24	NC	-		PB63B	4	
AG25	NC	-		PB64A	4	
AF25	NC	-		PB64B	4	
AG26	NC	-		PB65A	4	
AF27	NC	-		PB65B	4	
AD28	NC	-		PR56B	3	
AC27	NC	-		PR56A	3	
AE29	NC	-		PR53B	3	
AD29	NC	-		PR53A	3	
AB30	NC	-		NC	-	
AA28	NC	-		NC	-	
Y27	NC	-		PR47C	3	
W27	NC	-		PR47D	3	
V30	NC	-		PR47A	3	
W30	NC	-		PR47B	3	
W26	NC	-		PR43D	3	
V26	NC	-		PR43C	3	
U25	NC	-		PR42C	3	
T27	NC	-		PR40B	3	
R27	NC	-		PR40A	3	
V27	NC	-		PR39B	3	
U27	NC	-		PR39A	3	
U29	NC	-		PR36B	3	
T29	NC	-		PR36A	3	
T24	NC	-		PR35C	3	
Y25	NC	-		PR48C	3	
P24	NC	-		NC	-	
K28	NC	-		NC	-	
P23	NC	-		NC	-	
L28	NC	-		NC	-	
M27	NC	-		PR21B	2	
L27	NC	-		PR21A	2	
H27	NC	-		PR20B	2	
G27	NC	-		PR20A	2	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E22	VCC12	-		VCC12	-	
E21	VCC12	-		VCC12	-	
E3	VCC12	-		VCC12	-	
E4	VCC12	-		VCC12	-	
E6	VCC12	-		VCC12	-	
E7	VCC12	-		VCC12	-	
E8	VCC12	-		VCC12	-	
E9	VCC12	-		VCC12	-	
E11	VCC12	-		VCC12	-	
E12	VCC12	-		VCC12	-	
A23	GND	-		GND	-	
A31	GND	-		GND	-	
AA13	GND	-		GND	-	
AA15	GND	-		GND	-	
AA18	GND	-		GND	-	
AA20	GND	-		GND	-	
AA26	GND	-		GND	-	
AA6	GND	-		GND	-	
AB10	GND	-		GND	-	
AB24	GND	-		GND	-	
AC14	GND	-		GND	-	
AC22	GND	-		GND	-	
AC29	GND	-		GND	-	
AC3	GND	-		GND	-	
AD11	GND	-		GND	-	
AD19	GND	-		GND	-	
AD27	GND	-		GND	-	
AD7	GND	-		GND	-	
AF12	GND	-		GND	-	
AF18	GND	-		GND	-	
AF24	GND	-		GND	-	
AF30	GND	-		GND	-	
AF4	GND	-		GND	-	
AG15	GND	-		GND	-	
AG21	GND	-		GND	-	
AG9	GND	-		GND	-	
AJ10	GND	-		GND	-	
AJ16	GND	-		GND	-	
AJ20	GND	-		GND	-	
AJ26	GND	-		GND	-	
AJ29	GND	-		GND	-	
AJ4	GND	-		GND	-	
AK13	GND	-		GND	-	
AK17	GND	-		GND	-	
AK23	GND	-		GND	-	
AK7	GND	-		GND	-	
AL1	GND	-		GND	-	
AL32	GND	-		GND	-	
AM2	GND	-		GND	-	
AM31	GND	-		GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AL4	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AL3	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AD10	PR116D	3	
AD9	PR116C	3	
AH4	PR116B	3	
AJ4	PR116A	3	
AK5	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AJ5	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AM1	PR115B	3	
AL1	PR115A	3	
AH5	PR112D	3	
AG5	PR112C	3	
AL2	PR112B	3	
AK2	PR112A	3	
AB9	PR109D	3	
AC9	PR109C	3	
AH1	PR109B	3	
AG1	PR109A	3	
AE8	PR107D	3	VREF2_3
AD8	PR107C	3	
AJ3	PR107B	3	
AH3	PR107A	3	
AD7	PR104D	3	
AC7	PR104C	3	
AJ2	PR104B	3	
AH2	PR104A	3	
AF6	PR103D	3	
AF5	PR103C	3	
AF4	PR103B	3	
AE4	PR103A	3	
AD6	PR99D	3	
AC6	PR99C	3	
AG2	PR99B	3	
AF2	PR99A	3	
AC8	PR98D	3	
AB8	PR98C	3	
AK1	PR98B	3	
AJ1	PR98A	3	
AB10	PR96D	3	
AA10	PR96C	3	
AF3	PR96B	3	
AE3	PR96A	3	
AE5	PR94D	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P38	PL26B	7		PL40B	7	
N35	PL26C	7		PL40C	7	
N36	PL26D	7		PL40D	7	
N39	PL29A	7		PL43A	7	
P39	PL29B	7		PL43B	7	
R34	PL29C	7	VREF1_7	PL43C	7	VREF1_7
T34	PL29D	7	DIFFR_7	PL43D	7	DIFFR_7
L41	PL30A	7		PL44A	7	
M41	PL30B	7		PL44B	7	
W29	PL30C	7		PL44C	7	
Y29	PL30D	7		PL44D	7	
L42	PL31A	7		PL45A	7	
M42	PL31B	7		PL45B	7	
U32	PL31C	7		PL45C	7	
V32	PL31D	7		PL45D	7	
R37	PL33A	7		PL47A	7	
T37	PL33B	7		PL47B	7	
M36	PL33C	7		PL47C	7	
M37	PL33D	7		PL47D	7	
P40	PL34A	7		PL48A	7	
N40	PL34B	7		PL48B	7	
R35	PL34C	7		PL48C	7	
T35	PL34D	7		PL48D	7	
N41	PL35A	7		PL49A	7	
P41	PL35B	7		PL49B	7	
V33	PL35C	7		PL49C	7	
U33	PL35D	7		PL49D	7	
R38	PL37A	7		PL51A	7	
T38	PL37B	7		PL51B	7	
R36	PL37C	7		PL51C	7	
T36	PL37D	7		PL51D	7	
N42	PL38A	7		PL52A	7	
P42	PL38B	7		PL52B	7	
Y31	PL38C	7		PL52C	7	
AA31	PL38D	7		PL52D	7	
U37	PL39A	7		PL53A	7	
V37	PL39B	7		PL53B	7	
U34	PL39C	7		PL53C	7	
V34	PL39D	7		PL53D	7	
U39	PL41A	7		PL55A	7	
T39	PL41B	7		PL55B	7	
V35	PL41C	7		PL55C	7	
W35	PL41D	7		PL55D	7	
R41	PL42A	7		PL56A	7	
T41	PL42B	7		PL56B	7	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP1	PR90B	3		PR109B	3	
AN1	PR90A	3		PR109A	3	
AK10	PR89D	3	VREF2_3	PR107D	3	VREF2_3
AJ10	PR89C	3		PR107C	3	
AM5	PR89B	3		PR107B	3	
AL5	PR89A	3		PR107A	3	
AL7	PR86D	3		PR104D	3	
AK7	PR86C	3		PR104C	3	
AM1	PR86B	3		PR104B	3	
AL1	PR86A	3		PR104A	3	
AJ11	PR85D	3		PR103D	3	
AH11	PR85C	3		PR103C	3	
AK5	PR85B	3		PR103B	3	
AJ5	PR85A	3		PR103A	3	
AK9	PR84D	3		PR99D	3	
AJ9	PR84C	3		PR99C	3	
AK3	PR84B	3		PR99B	3	
AJ3	PR84A	3		PR99A	3	
AK6	PR82D	3		PR98D	3	
AJ6	PR82C	3		PR98C	3	
AK2	PR82B	3		PR98B	3	
AJ2	PR82A	3		PR98A	3	
AH10	PR81D	3		PR96D	3	
AG10	PR81C	3		PR96C	3	
AK1	PR81B	3		PR96B	3	
AJ1	PR81A	3		PR96A	3	
AH9	PR80D	3		PR94D	3	
AG9	PR80C	3		PR94C	3	
AH2	PR80B	3		PR94B	3	
AG2	PR80A	3		PR94A	3	
AH8	PR78D	3		PR92D	3	
AG8	PR78C	3		PR92C	3	
AG1	PR78B	3		PR92B	3	
AH1	PR78A	3		PR92A	3	
AG14	PR77D	3		PR91D	3	
AF14	PR77C	3		PR91C	3	
AG4	PR77B	3		PR91B	3	
AF4	PR77A	3		PR91A	3	
AH7	PR76D	3	DIFFR_3	PR90D	3	DIFFR_3
AG7	PR76C	3		PR90C	3	
AG3	PR76B	3		PR90B	3	
AF3	PR76A	3		PR90A	3	
AH6	PR74D	3		PR88D	3	
AG6	PR74C	3		PR88C	3	
AF1	PR74B	3		PR88B	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AB6	PR57D	3		PR71D	3	
AA6	PR57C	3		PR71C	3	
Y2	PR57B	3		PR71B	3	
W2	PR57A	3		PR71A	3	
AB7	PR56D	3		PR70D	3	
AA7	PR56C	3		PR70C	3	
Y3	PR56B	3		PR70B	3	
W3	PR56A	3		PR70A	3	
AC11	PR55D	3		PR69D	3	
AB11	PR55C	3	VREF1_3	PR69C	3	VREF1_3
Y4	PR55B	3		PR69B	3	
W4	PR55A	3		PR69A	3	
AB8	PR52D	3	PCLKC3_2	PR66D	3	PCLKC3_2
AA8	PR52C	3	PCLKT3_2	PR66C	3	PCLKT3_2
Y5	PR52B	3		PR66B	3	
W5	PR52A	3		PR66A	3	
AC12	PR51D	3	PCLKC3_3	PR65D	3	PCLKC3_3
AB12	PR51C	3	PCLKT3_3	PR65C	3	PCLKT3_3
V1	PR51B	3		PR65B	3	
U1	PR51A	3		PR65A	3	
W7	PR50D	3	PCLKC3_1	PR64D	3	PCLKC3_1
V7	PR50C	3	PCLKT3_1	PR64C	3	PCLKT3_1
V2	PR50B	3	PCLKC3_0	PR64B	3	PCLKC3_0
U2	PR50A	3	PCLKT3_0	PR64A	3	PCLKT3_0
AB9	PR48D	2	PCLKC2_2	PR62D	2	PCLKC2_2
AA9	PR48C	2	PCLKT2_2	PR62C	2	PCLKT2_2
T1	PR48B	2	PCLKC2_0	PR62B	2	PCLKC2_0
R1	PR48A	2	PCLKT2_0	PR62A	2	PCLKT2_0
AB10	PR47D	2	PCLKC2_3	PR61D	2	PCLKC2_3
AA10	PR47C	2	PCLKT2_3	PR61C	2	PCLKT2_3
U3	PR47B	2	PCLKC2_1	PR61B	2	PCLKC2_1
T3	PR47A	2	PCLKT2_1	PR61A	2	PCLKT2_1
Y9	PR46D	2		PR60D	2	
W9	PR46C	2		PR60C	2	
V5	PR46B	2		PR60B	2	
U5	PR46A	2		PR60A	2	
AA11	PR43D	2		PR57D	2	
Y11	PR43C	2		PR57C	2	
Y6	PR43B	2		PR57B	2	
W6	PR43A	2		PR57A	2	
Y10	PR42D	2		PR56D	2	
W10	PR42C	2		PR56C	2	
T2	PR42B	2		PR56B	2	
R2	PR42A	2		PR56A	2	
W8	PR41D	2		PR55D	2	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V8	PR41C	2		PR55C	2	
T4	PR41B	2		PR55B	2	
U4	PR41A	2		PR55A	2	
V9	PR39D	2		PR53D	2	
U9	PR39C	2		PR53C	2	
V6	PR39B	2		PR53B	2	
U6	PR39A	2		PR53A	2	
AA12	PR38D	2		PR52D	2	
Y12	PR38C	2		PR52C	2	
P1	PR38B	2		PR52B	2	
N1	PR38A	2		PR52A	2	
T7	PR37D	2		PR51D	2	
R7	PR37C	2		PR51C	2	
T5	PR37B	2		PR51B	2	
R5	PR37A	2		PR51A	2	
U10	PR35D	2		PR49D	2	
V10	PR35C	2		PR49C	2	
P2	PR35B	2		PR49B	2	
N2	PR35A	2		PR49A	2	
T8	PR34D	2		PR48D	2	
R8	PR34C	2		PR48C	2	
N3	PR34B	2		PR48B	2	
P3	PR34A	2		PR48A	2	
M6	PR33D	2		PR47D	2	
M7	PR33C	2		PR47C	2	
T6	PR33B	2		PR47B	2	
R6	PR33A	2		PR47A	2	
V11	PR31D	2		PR45D	2	
U11	PR31C	2		PR45C	2	
M1	PR31B	2		PR45B	2	
L1	PR31A	2		PR45A	2	
Y14	PR30D	2		PR44D	2	
W14	PR30C	2		PR44C	2	
M2	PR30B	2		PR44B	2	
L2	PR30A	2		PR44A	2	
T9	PR29D	2	DIFFR_2	PR43D	2	DIFFR_2
R9	PR29C	2	VREF1_2	PR43C	2	VREF1_2
P4	PR29B	2		PR43B	2	
N4	PR29A	2		PR43A	2	
N7	PR26D	2		PR40D	2	
N8	PR26C	2		PR40C	2	
P5	PR26B	2		PR40B	2	
N5	PR26A	2		PR40A	2	
K7	PR25D	2		PR38D	2	
J7	PR25C	2		PR38C	2	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-7FF1020C ¹	-7	Organic fcBGA	1020	COM	40.4
LFSC3GA40E-6FF1020C ¹	-6	Organic fcBGA	1020	COM	40.4
LFSC3GA40E-5FF1020C ¹	-5	Organic fcBGA	1020	COM	40.4
LFSC3GA40E-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-7FC1152C ²	-7	Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-6FC1152C ²	-6	Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-5FC1152C ²	-5	Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-7FF1152C	-7	Organic fcBGA	1152	COM	40.4
LFSC3GA40E-6FF1152C	-6	Organic fcBGA	1152	COM	40.4
LFSC3GA40E-5FF1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-7FF1020C ¹	-7	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-6FF1020C ¹	-6	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-5FF1020C ¹	-5	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-7FC1152C ²	-7	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FC1152C ²	-6	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FC1152C ²	-5	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-7FF1152C	-7	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FF1152C	-6	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FF1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).